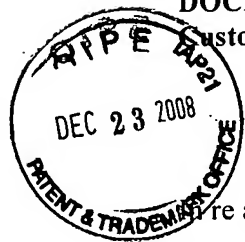


DOCKET NO.: 01-C-084 (STMI01-01084)

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PATENT

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re application of : Harry Michael Siegel, et al.  
Application No. : 10/066,245  
Filed : January 31, 2002  
For : METHOD FOR USING A PRE-FORMED FILM IN A TRANSFER  
MOLDING PROCESS FOR AN INTEGRATED CIRCUIT (AS  
AMENDED)  
Group No. : 1791  
Examiner : Edmund H. Lee  
Confirmation No. : 2782

MAIL STOP AF

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

The undersigned hereby certifies that the following documents:

1. Notice of Appeal;
2. Pre-Appeal Brief Request for Review;
3. Check in the amount of \$540.00 for the Notice of Appeal filing fee; and
4. Postcard Receipt

relating to the above application, were deposited as "First Class Mail", with the United States Postal Service, addressed to: MAIL STOP AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 19, 2008.

Date: 12/19/08

Date: 12-19-2008

P.O. Box 802432  
Dallas, Texas 75380  
Phone: (972) 628-3600  
Fax: (972) 628-3616  
E-mail: [dvenglarik@munckcarter.com](mailto:dvenglarik@munckcarter.com)

Kathy Longenecker  
Mailer  
Daniel E. Venglarik  
Reg. No. 39,409